FORM PTO-159 1-31-92 To the Honorable Commissioner of At Please record the attributed original doc.

1. Name of conveying parties: 1.) Hitoshi TAKAHASHI 2.) Hiroyoshi MAEDA 3.) Hideaki YOKKA

09-21-2005



103085784

U.S. Department of Commerce **Patent and Trademark Office** Attorney Docket No. 09812.0021-00000 Attorney Customer Number: 22,852

ATTN. BOX ASSIGNMENTS RECORDATION **SERVICES**

Name and address of receiving party:

Name:

SONY CORPORATION

7-35 KITASHINAGAWA 6-CHOME

4.) Eiji AMAYA	SHINAGAWA-KU, TOKYO, JAPAN	
Additional name of conveying party attached? ☐ Yes ☒ No	Internal Address:	
3. Nature of conveyance:	Street Address:	
☐ Assignment ☐ Merger	City:	
Security Change of Name Agreement	State: Zip Code:	
Other:	Additional name & Address attached?	
Execution Date: 1.) August 22, 2005 2.) August 22, 2005 3.) September 5, 2005 4.) August 23, 2005	☐ Yes	
4. Application number or patent number: If this document is being fi application:	led together with a new application, the execution date of the	
A. Patent Application Number:	B. Patent Number:	
11/177,357		
Additional numbers attached?	l ☐ Yes ☑ No	
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and registrations involved: 1	
Name: Mr. Ernest F. Chapman	7. Total fee (37 CFR 3.41): \$40	
	Enclosed (Please charge deficiency to deposit account)	
ENNEON HENDERSON SARAROW CARREST	Authorized to be charged to deposit account	
Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.		
Street Address: 901 New York Avenue, NW		
City: Washington, D.C.		
State: Zip: 20001-4413	8. Deposit Account No.: 06-0916	
9. Statement and signature.		
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		
Sin 10	SEP 1 6 2005	
David W. Hill, Reg. No. 28,220 Signa	eture ERNEST F. CHAPMAN Date	
Total number of pages including cover sheet, attachments and documents: 3		

09/20/2005 ECOOPER 00000231 11177357

01 FC:8021

PATENT REEL: 016998 FRAME: 0459

NO. 5279 P. 7

S05P0907US00

Docker	Number:	09812.0021
	remou.	

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

SYMBOL ILLUMINATION APPARATUS AND VIDEO DISPLAY APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration. the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America acheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention. applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application; said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement of encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/177,357 Filing Date: July 11, 2005 This assignment executed on the dates indicated below. Hitoshi TAKAHASHI Name of first or sole inventor Execution date of U.S. Patent Application Kanagawa, Japan Residence of first or sole inventor Aug. 22. 2005

REEL: 016998 FRAME: 0460

PATENT

Hiroyoshi MAEDA	
Name of second inventor	Execution date of U.S. Patent Application
Saitama, Japan	
Residence of second inventor	Aug. 22, 2005.
Signature of sedond inventor	Date of this assignment
Hideaki YOKKA	
Name of third inventor	Execution date of U.S. Patent Application
Toyama, Japan	
Residence of third inventor Hideaki Tokka	Gen 5 2005
Signature of third inventor	Sep 5 2005 Date of this assignment
Eiji AMAYA	
Name of fourth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of fourth inventor	Date of this assignment
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

RECORDED: 09/16/2005

PATENT REEL: 016998 FRAME: 0461